Introduction

This document helps customers to quickly locate information regarding touch sensing on STM32 microcontrollers.

It is applicable to STM32F0, STM32F3, STM32L0, STM32L1 and STM32L4 Series products. It lists all the existing application notes and user manuals covering touch sensing. It indicates where the key aspects of touch sensing are documented.

It also explains how to build touch sensing applications on STM32L0538-DISCO and STM32F072B-DISCO discovery boards using the STM32CubeMx graphical interface.
General information

This document applies to Arm®-based devices.

Note: Arm is a registered trademark of Arm Limited (or its subsidiaries) in the US and/or elsewhere.
2 Terminology and principle

2.1 Terminology

The touch sensing most relevant acronyms are described below:

- **Acquisition mode**
  - CT: Charge-Transfer acquisition principle. This mode is used on STM32 microcontrollers.

- **Touch sensing STM32 peripheral**
  - TSC: touch sensing controller peripheral
  - Bank: set of channels acquired simultaneously
  - Channel: elementary acquisition item
  - Group: set of 1..3 channels plus 1 sampling capacitor (Cs)

- **Sensors**
  - Touchkey or TKey: single channel sensor
  - Linear sensor: multi-channels sensor with the electrodes positioned in a linear way
  - Rotary sensor: multi-channels sensor with the electrodes positioned in a circular way
  - Active shield: track running along or copper plane surrounding the sensor track and/or sensor itself. Active shield is driven similarly to the sensor. Improve noise robustness without decreasing the sensitivity.

- **STM32 software**
  - TSL: touch sensing library
  - Delta: difference between the measure and the reference
  - Measure or meas: current signal measured on a channel
  - Reference or ref: reference signal based on the average of a sample of measures
  - DTO: detection time out. Time out is defined by TSLPRM_DTO. See TSLPRM_DTO in tsl_conf.h file.
  - DXS: detection exclusion system. Exclusion system is defined by TSLPRM_USE_DXS. See TSLPRM_USE_DXS in tsl_conf.h file.
  - ECS: environment change system. See TSLPRM_ECS_DELAY in tsl_conf.h file.

- **Hardware Involved**
  - Cx: sensor capacitance (typical value is few pF)
  - Cp: parasitic capacitance (typical value few pF)
  - Ct: equivalent touch capacitance
  - Cs/Cskey/Csshield: sampling capacitor (typical value from 2.2 to 100nF)
  - Rs/Rskey/Rsshield: serial resistor, ESD protection (typical value from 100Ohms to 10K)

2.2 Principle

The STM32 touch sensing feature is based on charge transfer.

The surface charge transfer acquisition principle consists in charging a sensor capacitance (Cx) and in transferring the accumulated charge into a sampling capacitor (Cs). This sequence is repeated until the voltage across Cs reaches $V_{IH}$.

The number of charge transfers required to reach the threshold is a direct representation of the size of the electrode capacitance. When the sensor is touched, the sensor capacitance to the earth is increased. This means the C voltage reaches $V_{IH}$ with less count and the measurement value decreases. When this measurement goes below a threshold, a detection is reported by the TSL. The schematic below do not take into account the parasitic capacitor.
Table 1. Change transfer principle documentation gives a list of documents containing information about the change transfer principle.

### Table 1. Change transfer principle documentation

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapters</th>
</tr>
</thead>
<tbody>
<tr>
<td>AN4299</td>
<td>Guidelines to improve conducted noise robustness on STM32F0/F3/L0/L4 series touch sensing applications</td>
<td>Surface charge transfer acquisition principle overview</td>
</tr>
<tr>
<td>AN4310</td>
<td>Sampling capacitor selection guide for MCU based touch sensing applications</td>
<td>Charge transfer acquisition principle overview</td>
</tr>
<tr>
<td>AN4312</td>
<td>Guidelines for designing touch sensing applications with surface sensors</td>
<td>Capacitive sensing technology in ST</td>
</tr>
<tr>
<td>AN4316</td>
<td>Tuning a STM32Touch-based application</td>
<td>Charge transfer period tuning</td>
</tr>
<tr>
<td>OLT</td>
<td>STM32L4 On Line Training</td>
<td>Touch sensing controller (TSC)</td>
</tr>
</tbody>
</table>
3 Document reference

Figure 2. Main documentation tree shows the main documentation tree related to TSC and TSL.

Figure 2. Main documentation tree

<table>
<thead>
<tr>
<th>Document name</th>
<th>Document title</th>
</tr>
</thead>
<tbody>
<tr>
<td>UM1913</td>
<td>Developing applications on STM32Cube with STMTouch® touch sensing library</td>
</tr>
<tr>
<td>AN3960</td>
<td>ESD considerations for touch sensing applications</td>
</tr>
<tr>
<td>AN4299</td>
<td>Guidelines to improve conducted noise robustness on STM32F0/F3/L0/L4 series touch sensing applications</td>
</tr>
<tr>
<td>AN4310</td>
<td>Sampling capacitor selection guide for MCU based touch sensing applications</td>
</tr>
<tr>
<td>AN4312</td>
<td>Guidelines for designing touch sensing applications with surface sensors</td>
</tr>
<tr>
<td>AN4316</td>
<td>Tuning a STMTouch-based application</td>
</tr>
</tbody>
</table>
STM32L4 touch sensing controller online presentation

An online training is available under our website www.st.com. Insert the STM32L4 Online Training string in the "Search" fuction and press enter. To find it use the function "Search" and insert the strings "STM32L4 Online Training". Figure 4. STM32L4 Touch Sensing Controller online training shows the online page available.

Figure 3. STM32L4 Online training

Figure 4. STM32L4 Touch Sensing Controller online training
5 Main characteristics

5.1 Description

The following Figure 5. TSC characteristics shows all touch sensing controller (TSC) characteristics and their correlation.

The TSC main characteristics are described in the following pages.

![Figure 5. TSC characteristics](image)

5.2 Signal threshold

To tune the detection thresholds, it must determine the sensitivity of each touchkey. For each touchkey, can be used few parameters to adjust these signal thresholds.

For debug purpose, it can get touchkey parameters using printf or STMStudio tool:

```c
for (Index = 0; Index < NUMBER_OF_TOUCHKEYS; Index++)
{
    printf("K%1d [%2d] [%4d %3d %3d %4d] %d %d %d %d %d",
          Index,
          MyTKeys[Index].p_Data->StateId,
          MyTKeys[Index].p_ChD->Ref,
          MyTKeys[Index].p_ChD->RefRest,
          MyTKeys[Index].p_ChD->Delta,
          MyTKeys[Index].p_ChD->Meas,
          MyTKeys[Index].p_Param->ProxInTh,
          MyTKeys[Index].p_Param->ProxOutTh,
          MyTKeys[Index].p_Param->DetectInTh,
          MyTKeys[Index].p_Param->DetectOutTh,
          MyTKeys[Index].p_Param->CalibTh
    );
}
```

Note: ProxInTh and ProxOutTh are defined for proximity detection feature only, when TSLPRM_USE_PROX = 1.
• On software side:
  – Relevant information are located in tsl_conf.h and tscl_user.c files.
  – Threshold (xx_TH) can be adjust in tsl_conf_tsc.h file.: See below an example:

```c
#define TSLPRM_TKEY_DETECT_IN_TH (64)
#define TSLPRM_TKEY_DETECT_OUT_TH (60)
#define TSLPRM_TKEY_CALIB_TH (56)
#define TSLPRM_LINROT_DETECT_IN_TH (50)
#define TSLPRM_LINROT_DETECT_OUT_TH (40)
```

• The TSL api, tsl_user_SetThresholds, located in tsi_user.c allows to adjust each channel independently. See below an example:

```c
void tsl_user_SetThresholds(void)
{
    /* USER CODE BEGIN Tsl_user_SetThresholds */
    /* Example: Decrease the Detect thresholds for the TKEY 0*/
    MyTKeys_Param[0].DetectInTh -= 10;
    MyTKeys_Param[0].DetectOutTh -= 10;
    /* USER CODE END Tsl_user_SetThresholds */
}
```

Table 3. Signal threshold usage documentation gives a list of documents containing information about the signal threshold usage.
Table 3. Signal threshold usage documentation

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapters</th>
</tr>
</thead>
<tbody>
<tr>
<td>UM1913</td>
<td>Developing applications on STM32Cube with STMTouch® touch sensing library</td>
<td>Debug with STMStudio</td>
</tr>
<tr>
<td>AN4316</td>
<td>Tuning a STMTouch-based application</td>
<td>Monitoring STMTouch driver variables using STMStudio&lt;br&gt;Tuning of the Thresholds&lt;br&gt;Touchkeys thresholds&lt;br&gt;Linear and Rotary touch sensors thresholds</td>
</tr>
</tbody>
</table>

### 5.3 Charge transfer

The acquisition is based on the measurement of the sensor channel capacitance. To ensure that the Cx capacitance is correctly charged, it is necessary to monitor the pin connected to the sensor. On sensors and shield sides, it must observe a complete Charge/Discharge cycle.

#### Figure 7. Incomplete and complete charge transfer cycle

In this example, to complete the charge transfer cycles, the following parameter must be modified as below:

- **INCREASE:**
  - htsc.Init.PulseGeneratorPrescaler
  - htsc.Init.CTPulseHighLength
  - htsc.Init.CTPulseLowLength

- **DECREASE:**
  - Sysclk

Table 4. Charge transfer documentation gives a list of documents containing information about the charge transfer.

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapters</th>
</tr>
</thead>
<tbody>
<tr>
<td>AN4299</td>
<td>Guidelines to improve conducted noise robustness on STM32F0/F3/L0/L4 series touch sensing applications</td>
<td>Active shield</td>
</tr>
<tr>
<td>AN4316</td>
<td>Tuning a STMTouch-based application</td>
<td>Charge transfer period tuning</td>
</tr>
</tbody>
</table>
5.4 Sensitivity

Sensitivity is a key point in touch sensing applications. The sensitivity can be improved by:

• Reduce air gap
• Reduce panel thickness
• Choose dielectric with higher $\varepsilon_R$
• GND plane must not too close from shield and sensors
• Avoid metallic paint near shield and sensors

Table 5. Sensitivity documentation gives a list of documents containing information about the sensitivity.

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapter</th>
</tr>
</thead>
<tbody>
<tr>
<td>AN1913</td>
<td>Developing applications on STM32Cube with STMTouch® touch sensing library</td>
<td>GPIO mode (table)</td>
</tr>
<tr>
<td>AN4312</td>
<td>Guidelines for designing touch sensing applications with surface sensors</td>
<td>Air Gap: Reduce air gap</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Changing the Panel material: Reduce Panel thickness Choose dielectric with higher $\varepsilon_R$</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Metal chassis: GND not too close from Shield and Sensors Avoid Metallic paint near Shield and Sensors</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Mechanical construction and PCB to panel bonding. Surface sensor design</td>
</tr>
<tr>
<td>AN4316</td>
<td>Tuning a STMTouch-based application</td>
<td>All chapter</td>
</tr>
</tbody>
</table>

Dielectric example

Table 6. Dielectric constants of common materials used in a panel construction

<table>
<thead>
<tr>
<th>Material</th>
<th>$\varepsilon_R$</th>
</tr>
</thead>
<tbody>
<tr>
<td>Air</td>
<td>1.00059</td>
</tr>
<tr>
<td>Glass</td>
<td>4 to 10</td>
</tr>
<tr>
<td>Sapphire glass</td>
<td>9 to 11</td>
</tr>
<tr>
<td>Mica</td>
<td>4 to 8</td>
</tr>
<tr>
<td>Nylon</td>
<td>3</td>
</tr>
<tr>
<td>Plexiglass</td>
<td>3.4</td>
</tr>
<tr>
<td>Polyethylene</td>
<td>2.2</td>
</tr>
<tr>
<td>Polystyrene</td>
<td>2.56</td>
</tr>
<tr>
<td>Polyethylene terephthalate (PET)</td>
<td>3.7</td>
</tr>
<tr>
<td>FR4 (fiberglass + epoxy)</td>
<td>4.2</td>
</tr>
<tr>
<td>PMMA (Poly methyl methacrylate)</td>
<td>2.6 to 4</td>
</tr>
<tr>
<td>Typical PSA</td>
<td>2.0 - 3.0 (approximately)</td>
</tr>
</tbody>
</table>
5.5 Sensors

- It is recommended to use the same shape for all electrodes.
- The touchkeys can be customized by the drawing on the panel. TSL compensates capacitance differences.
- Acquisition time and processing parameters can be optimized when electrodes have similar capacitance.

Sensor size example

![Figure 8. Sensor size](image)

5.5.1 Key

- Key sensors are used in common application
- You can get deeper key information in following documents:

Table 7. Key documentation gives a list of documents containing information about the key.

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapters</th>
</tr>
</thead>
<tbody>
<tr>
<td>UM1913</td>
<td>Developing applications on STM32Cube with STMTouch® touch sensing library</td>
<td>Touchkey sensor</td>
</tr>
<tr>
<td>AN4312</td>
<td>Guidelines for designing touch sensing applications with surface sensors</td>
<td>Touchkey sensor</td>
</tr>
</tbody>
</table>
5.5.2 **Linear or slider**

A linear is a set of contiguous capacitive electrodes. Figure 9, *Interlaced linear touch sensor with 3 channels / 4 electrodes (half-ended electrodes design)* shows a slider used on a discovery board.

**Figure 9. Interlaced linear touch sensor with 3 channels / 4 electrodes (half-ended electrodes design)**

![Diagram of linear touch sensor](image)

Legend:
- **Via between layers**
- **10% meshed ground plane**
- **Copper electrode**

Electrode gap 0.2~0.3 mm

Table 8. *Linear touch sensor documentation* gives a list of documents containing information about the linear touch sensor.

**Table 8. Linear touch sensor documentation**

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapters</th>
</tr>
</thead>
<tbody>
<tr>
<td>UM1913</td>
<td>Developing applications on STM32Cube with STMTouch® touch sensing library</td>
<td>Linear and rotary touch sensors</td>
</tr>
<tr>
<td>AN4312</td>
<td>Guidelines for designing touch sensing applications with surface sensors</td>
<td>Linear sensor</td>
</tr>
</tbody>
</table>
5.5.3 Rotary or wheel

A rotary is a set of contiguous capacitive electrodes.

**Figure 10. Interlaced patterned rotary sensor with 3 channels / 3 electrodes**

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapters</th>
</tr>
</thead>
<tbody>
<tr>
<td>UM1913</td>
<td>Developing applications on STM32Cube with STMTouch® touch sensing library</td>
<td>Linear and rotary touch sensors</td>
</tr>
<tr>
<td>AN4312</td>
<td>Guidelines for designing touch sensing applications with surface sensors</td>
<td>Rotary sensor</td>
</tr>
</tbody>
</table>

Table 9. Rotary sensor documentation gives a list of documents containing information about the rotary sensor.
5.5.4 Active shield or driven shield

Active shield or driven shield. (this name is used in some application notes) drives the shield plane with the same signal as the electrode.

There are several advantages using Active Shield instead of a grounded shield:
- The parasitic capacitance between the electrode and the shield no longer needs to be charged.
- Protect the touch electrodes from a noise source.
- Increase system stability and performance when a moving metal part is close to the electrode.

![Figure 11. Active shield principle](image)

Table 10. Active shield documentation gives a list of documents containing information about the active shield.

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapters</th>
</tr>
</thead>
<tbody>
<tr>
<td>AN4299</td>
<td>Guidelines to improve conducted noise robustness on STM32F0/F3/L0/L4 series touch sensing applications</td>
<td>Active Shield</td>
</tr>
<tr>
<td>AN4312</td>
<td>Guidelines for designing touch sensing applications with surface sensors</td>
<td>Driven shield</td>
</tr>
<tr>
<td>AN4316</td>
<td>Tuning a STMTouch-based application</td>
<td>Shield adjustment</td>
</tr>
<tr>
<td>OLT</td>
<td>STM32L4 Online Training</td>
<td>Touch sensing controller (TSC)</td>
</tr>
</tbody>
</table>
5.6 Layout and PCB
Rules to follow to improve TSC systems

5.6.1 Led rules

Table 11. Led rules documentation

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapters</th>
</tr>
</thead>
<tbody>
<tr>
<td>AN4312</td>
<td>Guidelines for designing touch sensing applications with surface sensors</td>
<td>• LEDs and Sensors.</td>
</tr>
<tr>
<td></td>
<td></td>
<td>• Placing of LEDs close to sensor</td>
</tr>
</tbody>
</table>

Figure 12. Led layout example

Figure 13. Example of cases where a LED bypass capacitor is required

Table 11. Led rules documentation

gives a list of documents containing information about led rules.
5.6.2 **Electrode not located on PCB**

It is possible but it is not recommended, because when the electrode is not located on PCB, the sensitivity decreases and additional extra parasitic capacitances are added.

**Figure 14. Electrode not located on PCB example**

Table 12. **Electrode documentation** gives a list of documents containing information about the electrode.

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapters</th>
</tr>
</thead>
<tbody>
<tr>
<td>AN4312</td>
<td>Guidelines for designing touch sensing applications with surface sensors</td>
<td>Using electrodes separated from the PCB</td>
</tr>
</tbody>
</table>
5.6.3 **Ground, shield and sensors**

Table 13 gives a list of documents containing information about the layout.

**Table 13. Layout documentation**

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapters</th>
</tr>
</thead>
</table>
| AN4312 | Guidelines for designing touch sensing applications with surface sensors | • PCB and Layout  
|       |                                                                      | • Ground considerations  
|       |                                                                      | • Rotary and linear sensor recommendations         |

Figure 15 shows the ground plane and the signal tracks.

**Figure 15. Hatched ground and signal tracks**

Figure 16 shows the ground plane example.

**Figure 16. Ground plane example**
Figure 17. Track routing

Figure 18. Track routing recommendation

- At least twice the panel thickness
- As thin as PCB technology allows
- At least twice the track width
- At least 2 mm (4 - 5 mm is recommended)

Any application track (LED, power, Com.)

Ground plane or ground track

Touchkey bank 1

Touchkey bank 2
Figure 19. Shield

Top layer

- Ground plane
- Track width (W)
- ~ 0.21
- 3-4 mm
- Active shield
- Sense plate

Bottom layer
5.6.4 FAQ

System keys points:
- Direct connection between earth and board ground is required to avoid conducted noise issues.
- Conductive painting on the front panel must be avoid.
- Robust mechanical assembly is required.

Layout keys points:
- GND plane is mandatory under MCU, sampling capacitors and up to serial resistors
- Hatched GND plane recommended for sensor traces from both sides of the PCB:
  - minimize parasitic capacitance
  - mesh plane possible with 25% to 40% copper
- Route the sensors and ground on the same layer while the components and other tracks are routed on the other layers

Driven shield, or Active shield, is recommended.
- If there will be LEDs close to sensors, to indicate a touch event, they must be bypassed by a capacitor. Typically 10 nF.
- External LDO regulator should be used to power the MCU only to provide a stable power supply voltage without any ripple, especially all the switching components like transistors, LEDs, in the application mustn't be powered from the same voltage. This regulator should not be placed close to the sensors and their tracks, but close to MCU.
- It is strongly recommended to dedicate pins to be used as touch sensors and do not share them with other features

R_S and C_S keys points:
- PPS or NPO sampling capacitors are recommended. Possible X5R or X7R.
- Never use tantalium sampling capacitors.
- Serial ESD 10 K (down to 1 K) resistors are recommended to be placed as close as possible to the MCU
- No track crossing or via between these resistors and the MCU
- The value of sampling capacitor of active shield should be different than the value of the sampling capacitors used for acquisition.
- The capacitance of active shield is higher (larger area) than C_X of a single touch sensing channel. In order to achieve the same waveform on active shield and active touch sensing channel, the ratios C_S/C_X of active shield and active touch sensing channel (touchkey). Therefore, the CS of the active shield should also have higher value (k x C_S of touch sensing channel).

Sensor key points:
- Other traces must not cross the touch sensing traces or the whole touch sensing area
- The touch sensing traces should be as thin as technology allows and as short as possible.
  - No longer than 10 cm
- The space between traces and GND plane should be ideally 5 mm
- TC pins are more robust against external interference than FT.
- Consider modification of PCB layout to allow connection of external VDD clamping diode to touch sensing electrode traces.
  - Use low-capacitance diode like BAR18, BAS70 with Cmax = 2 pF.
  - In case it is later needed, add pads and connection to the PCB without assembling components.
- Floating panes must never be placed close to the sensors.
5.7 Noise

Noise is a key point for touch sensing applications. Noise can come from Power supply.

5.7.1 Power supply

Main rules to follow:

• Place Buzzer and LED before LDO.
• Place LDO close to MCU.

![Figure 20. Typical power supply schematic](image)

Table 14. Power supply documentation gives a list of documents containing information about the power supply.

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapters</th>
</tr>
</thead>
<tbody>
<tr>
<td>AN4312</td>
<td>Guidelines for designing touch sensing applications with surface sensors</td>
<td>Power supply</td>
</tr>
</tbody>
</table>

5.7.2 False detection

To avoid false detection TSL embed ECS, DXS and DTO algorithms.

Table 15. False detection documentation gives a list of documents containing information about the false detection.

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapters</th>
</tr>
</thead>
</table>
| UM1913| Developing applications on STM32Cube with STMTouch® touch sensing library | • Environment Change System (ECS)  
• Detection Exclusion System (DXS)  
• Detection Time Out (DTO) |
5.7.3 Noise immunity

Noise filtering can be done on hardware and software (TSL) sides. Table 16. Noise immunity documentation gives a list of documents containing information about the noise immunity.

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapters</th>
</tr>
</thead>
<tbody>
<tr>
<td>UM1913</td>
<td>Developing applications on STM32Cube with STMTouch® touch sensing library</td>
<td>Noise filters</td>
</tr>
<tr>
<td>AN4299</td>
<td>Guidelines to improve conducted noise robustness on STM32F0/F3/L0/L4 series touch sensing applications</td>
<td>How to improve noise immunity</td>
</tr>
<tr>
<td>OLT</td>
<td>STM32L4 Online Training</td>
<td>Touch sensing controller (TSC)</td>
</tr>
</tbody>
</table>

5.7.4 Conducted noise

- Touch sensing systems requires the conducted noise immunity.
- A key point is the signal to noise ratio (SNR).
- The test condition to be followed by the user is described in the standard IEC61000-4-6.

Table 17. Conducted noise documentation gives a list of documents containing information about the conducted noise.

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapters</th>
</tr>
</thead>
<tbody>
<tr>
<td>AN4299</td>
<td>Guidelines to improve conducted noise robustness on STM32F0/F3/L0/L4 series touch sensing applications</td>
<td>All chapters</td>
</tr>
</tbody>
</table>
6 Tuning

For tuning purpose dedicated application note are available.

Sensors
Table 18. Sensors documentation gives a list of documents containing information about the sensor.

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapters</th>
</tr>
</thead>
<tbody>
<tr>
<td>AN4312</td>
<td>Guidelines for designing touch sensing applications with surface sensors</td>
<td>All chapters</td>
</tr>
</tbody>
</table>

ESD
Table 19. ESD documentation gives a list of documents containing information about the ESD

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapters</th>
</tr>
</thead>
<tbody>
<tr>
<td>AN3960</td>
<td>ESD considerations for touch sensing applications</td>
<td>All chapters</td>
</tr>
</tbody>
</table>

CN
Table 20. Conducted noise documentation gives a list of documents containing information about the conducted noise.

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapters</th>
</tr>
</thead>
<tbody>
<tr>
<td>AN4299</td>
<td>Guidelines to improve conducted noise robustness on STM32F0/F3/L0/L4 series touch sensing applications</td>
<td>All chapters</td>
</tr>
</tbody>
</table>

CS
Table 21. Sampling capacitor documentation gives a list of documents containing information about the sampling capacitor.

<table>
<thead>
<tr>
<th>Id</th>
<th>Title</th>
<th>Chapters</th>
</tr>
</thead>
<tbody>
<tr>
<td>AN4310</td>
<td>Sampling capacitor selection guide for MCU based touch sensing applications</td>
<td>All chapters</td>
</tr>
</tbody>
</table>
7 Getting started TSC with STM32CubeMX

7.1 Uses cases

How to set-up an TSC application based on TSL is explained in the following two examples. These examples describe the way to set-up TLS on STM32F072B-DISCO and STM32L0538-DISCO discovery boards. This description can be used as example to set-up others TSC series such as L4, F3, L0, L1 and L4.

An STM32CubeMX new feature is available from version 4.24.0. This new feature can help to speed-up TSL, TouchSensingLib, installation.

Figure 21. Main project panel
7.2 Discovery board: STM32F072B-DISCO

The STM32F072 Discovery kit helps the user to discover the STM32F072, which has the full set of features available in the STM32F0 Series, and to develop his applications easily. It includes everything required for beginners and experienced users to get started quickly. Based on the STM32F072RBT6, it includes an ST-LINK/V2 embedded debug tool interface, an ST MEMS gyroscope, LEDs, push-buttons, linear touch sensor, RF EEPROM connector and a USB mini-B connector. This discovery board provide a three channels linear (or slider) sensor. The main characteristics of these sensor are:

- On-board ST-LINK/V2
- Supply through ST-Link USB
- External Supply: 3V and 5V
- JP2 (Idd) for current measurement
- Full-Speed USB with mini-B Connector
- Motion sensor, 3-axis digital output gyroscope (L3GD20)
- One Linear Touch Sensor or four Touch Keys
- Two Push-buttons: User and Reset
- Six LEDs: USB COM, 3.3 V Power, User (Orange/Green/Red/Blue)
- Extension header: (2 x 33) with 2.54 mm Pitch
- Discovery Board Formfactor

7.2.1 STM32F072B-DISCO board selection

Start to select STM32F072B-DISCO board.

Figure 22. STM32F072B-DISCO board selection

To start Linear Touch Sensor channel acquisition at the same time, three groups are used. (See Figure 23. STM32F072B-DISCO board schematics)
Figure 23. STM32F072B-DISCO board schematics

Linear sensor track of 3 electrodes

Interlaced slider with three elements (up to 60 mm long)
7.2.2 STM32F072B-DISCO TSC group and sensor activation

To activate the TSC group, sampling capacitors and sensor channels follows the below steps:

- activate TSC according schematics information.
- desactivate unrelevant peripheral like USB, SPI, NCF(L0), EPaper(L0), MFX(L0)

SWD peripheral must be set according to Figure 24.

**Figure 24. STM32F072B-DISCO pinout SWD**

TSC peripheral must be set according to Figure 25.

**Figure 25. STM32F072B-DISCO pinout TSC**
Figure 26 shows the results obtained.

**Figure 26. STM32F072B-DISCO pinout overview**

7.2.3 **STM32F072B-DISCO clock tree**

It uses the default clock tree setting.

**Figure 27. STM32F072B-DISCO clock configuration**
7.2.4 STM32F072B-DISCO touchsensing library

To activate the TLS usage, switch on TOUCHSENSING box configuration.

Figure 28. TOUCHSENSING box configuration

Select three channels Linear slider and assign dedicated Gx_IOy (see previous chapter or schematics for details).

- For training purpose, we can used three channels Linear slider as three keys sensors.
- Select three keys and assign dedicated Gx_IOy (see previous chapter or schematics for details).

Figure 29 to Figure 33 show these steps.

Figure 29. STM32F072B-DISCO sensor selection
Figure 32. STM32F072B-DISCO sensor selection step4

<table>
<thead>
<tr>
<th>Sensor Type</th>
<th>Configuration</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>Temperature</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>Humidity</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>Pressure</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>Vibration</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>Others</td>
<td>-</td>
<td>-</td>
</tr>
</tbody>
</table>

Figure 33. STM32F072B-DISCO sensor selection step5

<table>
<thead>
<tr>
<th>Sensor Type</th>
<th>Configuration</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>Temperature</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>Humidity</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>Pressure</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>Vibration</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>Others</td>
<td>-</td>
<td>-</td>
</tr>
</tbody>
</table>
7.2.5 STM32F072B-DISCO software project generation

Now, it is possible to generate the complete software project based on TSC HAL and TSL. Figure 34 to Figure 37 show all these steps.

**Figure 34. STM32F072B-DISCO software generation step1**

![Software generation step 1](image1)

**Figure 35. STM32F072B-DISCO software generation step2**

![Software generation step 2](image2)
Figure 36. STM32F072B-DISCO software generation step3

Figure 37. STM32F072B-DISCO IDE workspace
7.2.6 STM32F072B-DISCO software basic algorithm

The user needs now to write the main application loop.

Example to show keys usage instead of slider usage.

- Open your IDE and in main.c file add the following lines:

```c
/* USER CODE BEGIN 3 */
extern TSL_LinRot_T MyLinRots[];
static uint32_t cnt=0;
tsl_user_status_t status = TSL_USER_STATUS_BUSY;
status = tsl_user_Exec();
if(TSL_USER_STATUS_BUSY == status)
{
    // Nothing to do
    if(cnt++%50==0)
    {
        HAL_GPIO_TogglePin(LD3_GPIO_Port, LD3_Pin);
    }
    HAL_Delay(1);
}
else
{
    if(MyLinRots[0].p_Data->StateId == TSL_STATEID_DETECT)
    {
        //TSLPRM_LINROT_RESOLUTION
        if(MyLinRots[0].p_Data->Position >= 5 && MyLinRots[0].p_Data->Position < 50)
        {
            HAL_GPIO_WritePin(LD4_GPIO_Port, LD4_Pin, GPIO_PIN_SET);
            HAL_GPIO_WritePin(LD6_GPIO_Port, LD6_Pin, GPIO_PIN_RESET);
            HAL_GPIO_WritePin(LD5_GPIO_Port, LD5_Pin, GPIO_PIN_RESET);
        }
        if(MyLinRots[0].p_Data->Position >= 50 && MyLinRots[0].p_Data->Position < 80)
        {
            HAL_GPIO_WritePin(LD6_GPIO_Port, LD6_Pin, GPIO_PIN_SET);
            HAL_GPIO_WritePin(LD4_GPIO_Port, LD4_Pin, GPIO_PIN_RESET);
            HAL_GPIO_WritePin(LD5_GPIO_Port, LD5_Pin, GPIO_PIN_RESET);
        }
        if(MyLinRots[0].p_Data->Position >= 80 && MyLinRots[0].p_Data->Position < 120)
        {
            HAL_GPIO_WritePin(LD5_GPIO_Port, LD5_Pin, GPIO_PIN_SET);
            HAL_GPIO_WritePin(LD4_GPIO_Port, LD4_Pin, GPIO_PIN_RESET);
            HAL_GPIO_WritePin(LD6_GPIO_Port, LD6_Pin, GPIO_PIN_RESET);
        }
    }
    else //if(MyLinRots[0].p_Data->StateId == TSL_STATEID_RELEASE)
    {
        HAL_GPIO_WritePin(LD4_GPIO_Port, LD4_Pin, GPIO_PIN_RESET);
        HAL_GPIO_WritePin(LD5_GPIO_Port, LD5_Pin, GPIO_PIN_RESET);
        HAL_GPIO_WritePin(LD6_GPIO_Port, LD6_Pin, GPIO_PIN_RESET);
    }
}
/* USER CODE END 3 */
```

Take care of ST-Link setup, see Figure 38. STM32F072B-DISCO setup.
Now the system is functional and ready to be used. Led will blink according finger position on slider.
7.3 Discovery board: STM32L0538-DISCO

The STM32L053 discovery kit helps you to discover the ultra-low-power microcontrollers of the STM32L0 series. It offers everything required for beginners and experienced users to get started quickly and develop applications easily.

Based on an STM32L053C8T6, it includes an ST-LINK/V2-1 embedded debug tool interface, linear touch sensor, IDD current measurement, 2.04" E-paper display, NFC connector for PLUG-CR95HF-B board, LEDs, pushbuttons and a USB Mini-B connector.

This discovery board provides a three channels linear (or slider) sensor. Their main characteristics are:

- On-board ST-LINK/V2-1
- Supply through ST-Link USB
- External Supply: 3V and 5V
- JP4 (Idd) for current measurement
- Full-Speed USB with mini-B Connector
- E-paper 2.04" display (172 x 72)
- One Linear Touch Sensor or four Touch Keys
- Two Push-buttons: User and Reset
- Four LEDs: USB COM, 3.3 V Power, user (Green/Red)
- Extension header: (2 x 25) with 2.54 mm Pitch
- Discovery Board Formfactor

7.3.1 STM32L0538-DISCO board selection

Start to select STM32L0538-DISCO board.

Figure 39. STM32L0538-DISCO board selection

To start linear touch sensor channel acquisition at the same time, three groups are used.
Figure 40. STM32L0538-DISCO board schematics
7.3.2 STM32L0538-DISCO TSC group and sensor activation

To activate the TSC group, sampling capacitors and sensor channels follows the below steps:

- Activate TSC according to schematics information.
- You can deactivate irrelevant peripheral like USB, SPI, NCF(L0), EPaper(L0), MFX(L0)

SWD peripheral must be set according to Figure 41.

Figure 41. Pinout SWD

TSC peripheral must be set according to Figure 42.

Figure 42. Pinout TSC
Figure 43 shows the results obtained.

**Figure 43. Pinout overview**

7.3.3 **STM32L0538-DISCO clock tree**

It uses the default clock tree setting.

**Figure 44. Clock configuration**
7.3.4 STM32L0538-DISCO touchsensing library
To activate the TLS usage, switch on TOUCHSENSING box configuration.

Select 3 channels Linear slider and assign dedicated Gx_IOy (see previous chapter or schematics for details). For training purpose, the user can:

- use three channels linear slider as three keys sensors
- Select three keys and assign dedicated Gx_IOy (see previous chapter or schematics for details).

Follow Figure 46 to Figure 50 to set sensors.
**Figure 47. STM32L0538-DISCO sensor selection step2**

<table>
<thead>
<tr>
<th>Sensor</th>
<th>Name</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Sensor 1</td>
<td>Sensor 1</td>
<td>Value 1</td>
</tr>
<tr>
<td>Sensor 2</td>
<td>Sensor 2</td>
<td>Value 2</td>
</tr>
</tbody>
</table>

**Figure 48. STM32L0538-DISCO sensor selection step3**

<table>
<thead>
<tr>
<th>Sensor</th>
<th>Name</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Sensor 1</td>
<td>Sensor 1</td>
<td>Value 1</td>
</tr>
<tr>
<td>Sensor 2</td>
<td>Sensor 2</td>
<td>Value 2</td>
</tr>
</tbody>
</table>

Diagram showing sensor selection configuration.
Figure 49. STM32L0538-DISCO sensor selection step 4

Figure 50. STM32L0538-DISCO sensor selection step 5
7.3.5 STM32L0538-DISCO software project generation

Now, it is possible to generate the complete software project based on TSC HAL and TSL. See details in Figure 51 to Figure 55.

**Figure 51. STM32L0538-DISCO software generation step1**

[Image of software generation step 1]

**Figure 52. STM32L0538-DISCO software generation step2**

[Image of software generation step 2]
Figure 53. STM32L0538-DISCO complete project overview

Figure 54. STM32L0538-DISCO IDE workspace

Figure 55. SWD settings
STM32L0538-DISCO software basic algorithm

Below is showed an example to show keys usage instead of slider usage.

- Open your IDE and in main.c file add the following lines:

```c
/* USER CODE BEGIN 3 */
extern TSL_TouchKey_T MyTKeys[];
static uint32_t    cnt=0;
 tsl_user_status_t status = TSL_USER_STATUS_BUSY;
status = tsl_user_Exec();
if(TSL_USER_STATUS_BUSY == status)
{   // Nothing to do
    if(cnt++%50==0){
    }   HAL_Delay(1);
} else{
    HAL_GPIO_WritePin(LD_R_GPIO_Port, LD_R_Pin, GPIO_PIN_RESET);    //00
    HAL_GPIO_WritePin(LD_G_GPIO_Port, LD_G_Pin, GPIO_PIN_RESET);
    if(MyTKeys[0].p_Data->StateId == TSL_STATEID_DETECT)
    {
        HAL_GPIO_WritePin(LD_R_GPIO_Port, LD_R_Pin, GPIO_PIN_SET); //11
        HAL_GPIO_WritePin(LD_G_GPIO_Port, LD_G_Pin, GPIO_PIN_SET);
    }
    if(MyTKeys[1].p_Data->StateId == TSL_STATEID_DETECT)
    {
        HAL_GPIO_WritePin(LD_R_GPIO_Port, LD_R_Pin, GPIO_PIN_SET); //01
        HAL_GPIO_WritePin(LD_G_GPIO_Port, LD_G_Pin, GPIO_PIN_RESET);
    }
    if(MyTKeys[2].p_Data->StateId == TSL_STATEID_DETECT)
    {
        HAL_GPIO_WritePin(LD_R_GPIO_Port, LD_R_Pin, GPIO_PIN_RESET);//01
        HAL_GPIO_WritePin(LD_G_GPIO_Port, LD_G_Pin, GPIO_PIN_SET);
    }
} /* USER CODE BEGIN 3 */
```

Now the system is functional and ready to be used.
The Led is blink according to the position of the on slider.
Revision history

Table 22. Document revision history

<table>
<thead>
<tr>
<th>Date</th>
<th>Version</th>
<th>Changes</th>
</tr>
</thead>
<tbody>
<tr>
<td>19-Sep-2018</td>
<td>1</td>
<td>Initial release.</td>
</tr>
</tbody>
</table>
Contents

1 General information ............................................................... 2

2 Terminology and principle ......................................................... 3
   2.1 Terminology ................................................................... 3
   2.2 Principle ...................................................................... 3

3 Document reference ..................................................................... 5

4 STM32L4 touch sensing controller online presentation ......................... 6

5 Main characteristics ............................................................... 7
   5.1 Description .................................................................... 7
   5.2 Signal threshold. .......................................................... 7
   5.3 Charge transfer ........................................................... 9
   5.4 Sensitivity ................................................................ 10
   5.5 Sensor ...................................................................... 10
       5.5.1 Key .................................................................. 11
       5.5.2 Linear or slider ..................................................... 12
       5.5.3 Rotary or wheel .................................................... 13
       5.5.4 Active shield or driven shield. ................................. 14
   5.6 Layout and PCB ............................................................ 15
       5.6.1 Led rules .............................................................. 15
       5.6.2 Electrode not located on PCB ................................. 16
       5.6.3 Ground, shield and sensors ................................. 17
       5.6.4 FAQ ................................................................. 20
   5.7 Noise........................................................................ 21
       5.7.1 Power supply ......................................................... 21
       5.7.2 False detection ...................................................... 21
       5.7.3 Noise immunity .................................................... 22
       5.7.4 Conducted noise .................................................... 22

6 Tuning............................................................................ 23

7 Getting started TSC with STM32CubeMX ......................................... 24
   7.1 Uses cases .................................................................. 24
7.2 Discovery board: STM32F072B-DISCO ................................................................. 25
  7.2.1 STM32F072B-DISCO board selection ................................................... 25
  7.2.2 TSC group and sensor activation .......................................................... 27
  7.2.3 STM32F072B-DISCO clock tree .............................................................. 28
  7.2.4 STM32F072B-DISCO touchsensing library .......................................... 29
  7.2.5 STM32F072B-DISCO software project generation ................................. 32
  7.2.6 Software basic algorithm .................................................................... 34

7.3 Discovery board: STM32L0538-DISCO ......................................................... 36
  7.3.1 STM32L0538-DISCO board selection .................................................... 36
  7.3.2 STM32L0538-DISCO TSC group and sensor activation ......................... 38
  7.3.3 STM32L0538-DISCO clock tree .............................................................. 39
  7.3.4 STM32L0538-DISCO touchsensing library .......................................... 40
  7.3.5 STM32L0538-DISCO software project generation ................................. 43
  7.3.6 STM32L0538-DISCO software basic algorithm ..................................... 45

Revision history ............................................................................................... 46
List of tables

Table 1. Change transfer principle documentation ................................................... 4
Table 2. References documentation ........................................................................ 5
Table 3. Signal threshold usage documentation ...................................................... 9
Table 4. Charge transfer documentation .................................................................. 9
Table 5. Sensitivity documentation ......................................................................... 10
Table 6. Dielectric constants of common materials used in a panel construction ....... 10
Table 7. Key documentation ..................................................................................... 11
Table 8. Linear touch sensor documentation ........................................................... 12
Table 9. Rotary sensor documentation ..................................................................... 13
Table 10. Active shield documentation ................................................................... 14
Table 11. Led rules documentation .......................................................................... 15
Table 12. Electrode documentation .......................................................................... 16
Table 13. Layout documentation ............................................................................. 17
Table 14. Power supply documentation .................................................................. 21
Table 15. False detection documentation ................................................................. 21
Table 16. Noise immunity documentation ................................................................ 22
Table 17. Conducted noise documentation .............................................................. 22
Table 18. Sensors documentation ........................................................................... 23
Table 19. ESD documentation ................................................................................ 23
Table 20. Conducted noise documentation .............................................................. 23
Table 21. Sampling capacitor documentation ........................................................... 23
Table 22. Document revision history ...................................................................... 46
## List of figures

<table>
<thead>
<tr>
<th>Figure</th>
<th>Description</th>
<th>Page</th>
</tr>
</thead>
<tbody>
<tr>
<td>Figure 1</td>
<td>Change transfer principle</td>
<td>4</td>
</tr>
<tr>
<td>Figure 2</td>
<td>Main documentation tree</td>
<td>5</td>
</tr>
<tr>
<td>Figure 3</td>
<td>STM32L4 online training</td>
<td>6</td>
</tr>
<tr>
<td>Figure 4</td>
<td>STM32L4 Touch Sensing Controller online training</td>
<td>6</td>
</tr>
<tr>
<td>Figure 5</td>
<td>TSC characteristics</td>
<td>7</td>
</tr>
<tr>
<td>Figure 6</td>
<td>STMStudio outputs</td>
<td>8</td>
</tr>
<tr>
<td>Figure 7</td>
<td>Incomplete and complete charge transfert cycle</td>
<td>9</td>
</tr>
<tr>
<td>Figure 8</td>
<td>Sensor size</td>
<td>11</td>
</tr>
<tr>
<td>Figure 9</td>
<td>Interlaced linear touch sensor with 3 channels / 4 electrodes (half-ended electrodes design)</td>
<td>12</td>
</tr>
<tr>
<td>Figure 10</td>
<td>Interlaced patterned rotary sensor with 3 channels / 3 electrodes</td>
<td>13</td>
</tr>
<tr>
<td>Figure 11</td>
<td>Active shield principle</td>
<td>14</td>
</tr>
<tr>
<td>Figure 12</td>
<td>Led layout example</td>
<td>15</td>
</tr>
<tr>
<td>Figure 13</td>
<td>Example of cases where a LED bypass capacitor is required</td>
<td>15</td>
</tr>
<tr>
<td>Figure 14</td>
<td>Electrode not located on PCB example</td>
<td>16</td>
</tr>
<tr>
<td>Figure 15</td>
<td>Hatched ground and signal tracks</td>
<td>17</td>
</tr>
<tr>
<td>Figure 16</td>
<td>Ground plane example</td>
<td>17</td>
</tr>
<tr>
<td>Figure 17</td>
<td>Track routing</td>
<td>18</td>
</tr>
<tr>
<td>Figure 18</td>
<td>Track routing recommendation</td>
<td>18</td>
</tr>
<tr>
<td>Figure 19</td>
<td>Shield</td>
<td>19</td>
</tr>
<tr>
<td>Figure 20</td>
<td>Typical power supply schematic</td>
<td>21</td>
</tr>
<tr>
<td>Figure 21</td>
<td>Main project panel</td>
<td>24</td>
</tr>
<tr>
<td>Figure 22</td>
<td>STM32F072B-DISCO board selection</td>
<td>25</td>
</tr>
<tr>
<td>Figure 23</td>
<td>STM32F072B-DISCO board schematics</td>
<td>26</td>
</tr>
<tr>
<td>Figure 24</td>
<td>STM32F072B-DISCO pinout SWD</td>
<td>27</td>
</tr>
<tr>
<td>Figure 25</td>
<td>STM32F072B-DISCO pinout TSC</td>
<td>27</td>
</tr>
<tr>
<td>Figure 26</td>
<td>STM32F072B-DISCO pinout overview</td>
<td>28</td>
</tr>
<tr>
<td>Figure 27</td>
<td>STM32F072B-DISCO clock configuration</td>
<td>28</td>
</tr>
<tr>
<td>Figure 28</td>
<td>TOUCHSENSING box configuration</td>
<td>29</td>
</tr>
<tr>
<td>Figure 29</td>
<td>STM32F072B-DISCO sensor selection</td>
<td>29</td>
</tr>
<tr>
<td>Figure 30</td>
<td>STM32F072B-DISCO sensor selection step2</td>
<td>30</td>
</tr>
<tr>
<td>Figure 31</td>
<td>STM32F072B-DISCO sensor selection step3</td>
<td>30</td>
</tr>
<tr>
<td>Figure 32</td>
<td>STM32F072B-DISCO sensor selection step4</td>
<td>31</td>
</tr>
<tr>
<td>Figure 33</td>
<td>STM32F072B-DISCO sensor selection step5</td>
<td>31</td>
</tr>
<tr>
<td>Figure 34</td>
<td>STM32F072B-DISCO software generation step1</td>
<td>32</td>
</tr>
<tr>
<td>Figure 35</td>
<td>STM32F072B-DISCO software generation step2</td>
<td>32</td>
</tr>
<tr>
<td>Figure 36</td>
<td>STM32F072B-DISCO software generation step3</td>
<td>33</td>
</tr>
<tr>
<td>Figure 37</td>
<td>STM32F072B-DISCO IDE workspace</td>
<td>33</td>
</tr>
<tr>
<td>Figure 38</td>
<td>STM32F072B-DISCO setup</td>
<td>35</td>
</tr>
<tr>
<td>Figure 39</td>
<td>STM32L0538-DISCO board selection</td>
<td>36</td>
</tr>
<tr>
<td>Figure 40</td>
<td>STM32L0538-DISCO board schematics.</td>
<td>37</td>
</tr>
<tr>
<td>Figure 41</td>
<td>Pinout SWD</td>
<td>38</td>
</tr>
<tr>
<td>Figure 42</td>
<td>Pinout TSC</td>
<td>38</td>
</tr>
<tr>
<td>Figure 43</td>
<td>Pinout overview</td>
<td>39</td>
</tr>
<tr>
<td>Figure 44</td>
<td>Clock configuration</td>
<td>39</td>
</tr>
<tr>
<td>Figure 45</td>
<td>TOUCHSENSING box configuration</td>
<td>40</td>
</tr>
<tr>
<td>Figure 46</td>
<td>STM32L0538-DISCO sensor selection step1</td>
<td>40</td>
</tr>
<tr>
<td>Figure 47</td>
<td>STM32L0538-DISCO sensor selection step2</td>
<td>41</td>
</tr>
<tr>
<td>Figure 48</td>
<td>STM32L0538-DISCO sensor selection step3</td>
<td>41</td>
</tr>
<tr>
<td>Figure 49</td>
<td>STM32L0538-DISCO sensor selection step4</td>
<td>42</td>
</tr>
<tr>
<td>Figure 50</td>
<td>STM32L0538-DISCO sensor selection step5</td>
<td>42</td>
</tr>
<tr>
<td>Figure 51</td>
<td>STM32L0538-DISCO software generation step1</td>
<td>43</td>
</tr>
<tr>
<td>Figure 52</td>
<td>STM32L0538-DISCO software generation step2</td>
<td>43</td>
</tr>
</tbody>
</table>
Figure 53. STM32L0538-DISCO complete project overview ............................................ 44
Figure 54. STM32L0538-DISCO IDE workspace ................................................... 44
Figure 55. SWD settings .................................................................... 44